



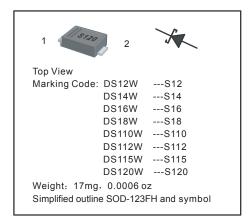
# Surface Mount Schottky Barrier Rectifier Reverse Voltage - 20 to 200 V Forward Current - 1.0 A

#### **Features**

- · Metal silicon junction, majority carrier conduction
- For surface mounted applications
- · Low power loss, high efficiency
- · High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

#### **PINNING**

PIN	DESCRIPTION				
1	Cathode				
2	Anode				



#### Absolute Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter	Symbols	DS12W	DS14W	DS16W	DS18W	DS110W	DS112W	DS115W	DS120W	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	20	40	60	80	100	120	150	200	V
Maximum RMS voltage	V <sub>RMS</sub>	14	28	42	56	70	84	105	140	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	20	40	60	80	100	120	150	200	V
Maximum Average Forward Rectified Current	I <sub>F(AV)</sub>	1.0							А	
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I <sub>FSM</sub>	40				30				А
Max Instantaneous Forward Voltage at 1 A	V <sub>F</sub>	0.	55	0.70		0.85		0.90		٧
Maximum DC Reverse Current $T_a = 25^{\circ}C$ at Rated DC Reverse Voltage $T_a = 100^{\circ}C$	I <sub>R</sub>	0.3 10			0.2 5		0.1		m A	
Typical Junction Capacitance 1)	Cj	110 80						pF		
Typical Thermal Resistance 2)	R <sub>eJA</sub>	115							°C/W	
Typical Current Squared Time	Ι <sup>2</sup> Τ	6.64						A²S		
Operating Junction Temperature Range	Tj	- 55 ~ +150							°C	
Storage Temperature Range	$T_{stg}$	-55 ~ +150						°C		

- 1) Measured at 1MHz and applied reverse voltage of 4 V D.C.
- 2) P.C.B. mounted with 0.2 X 0.2" (5 X 5 mm) copper pad areas.

## RATING AND CHARACTERISTICS CURVES (DS12W THRU DS120W)

Fig.1 Forward Current Derating Curve

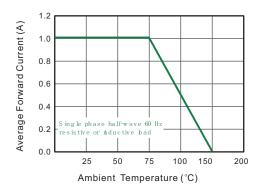


Fig.2 Typical Reverse Characteristics

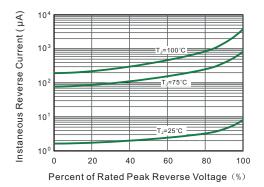


Fig.3 Typical Forward Characteristic

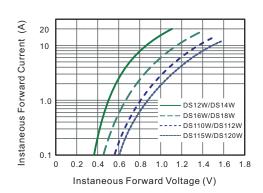


Fig.4 Typical Junction Capacitance

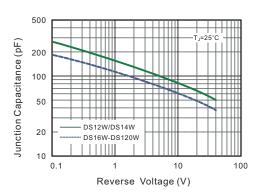


Fig.5 Maximum Non-Repetitive Peak Forward Surage Current

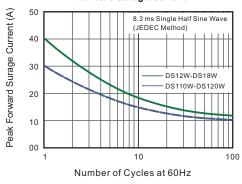
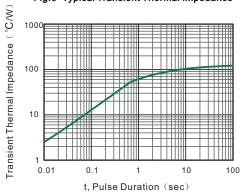


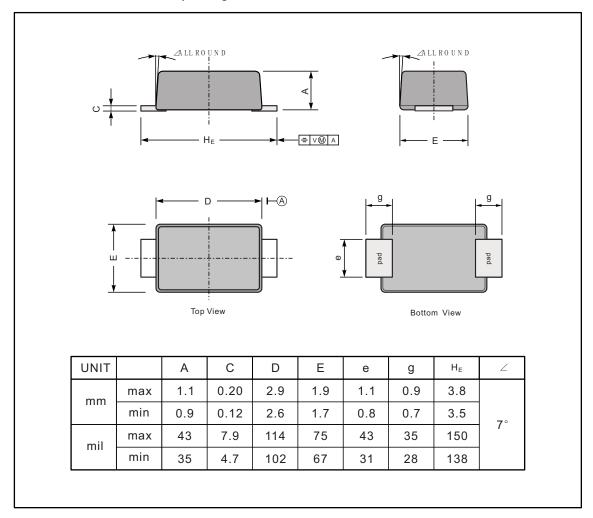
Fig.6- Typical Transient Thermal Impedance



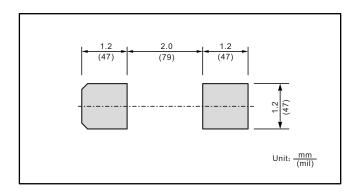


## PACKAGE OUTLINE

## Plastic surface mounted package; 2 leads



## The recommended mounting pad size

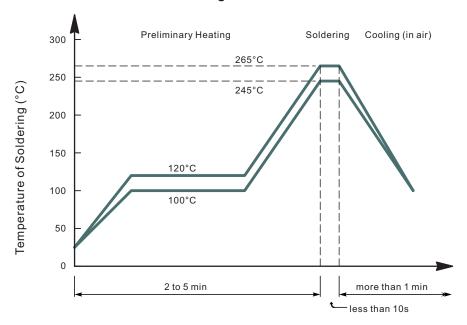


## Marking

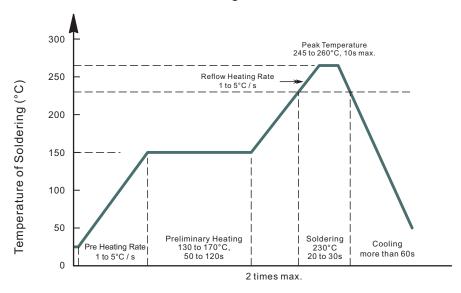
Type number	Marking code				
DS12W	S12				
DS14W	S14				
DS16W	S16				
DS18W	S18				
DS110W	S110				
DS112W	S112				
DS115W	S115				
DS120W	S120				



## • Recommended condition of flow soldering



#### Recommended condition of reflow soldering



Recommended peak temperature is over 245 °C. If peak temperature is below 245 °C, you may adjust the following parameters; time length of peak temperature (longer), time length of soldering (longer), thickness of solder paste (thicker)

## Condition of hand soldering

Temperature: 350°C

Time: 3s max. Times: one time

#### • Remark:

Lead free solder paste (96.5Sn/3.0Ag/0.5Cu)



# PACKAGING OF DIODE AND BRIDGE RECTIFIERS

#### REEL PACK

PACKAGE	PACKING CODE	EA PER REEL	EA PER INNER BOX	COMPONENT SPACE (mm)	TAPE SPACE (mm)	REEL DIA (mm)	CARTON SIZE (mm)	EA PER CARTON	GROSS WEIGHT(Kg)
SOD-123FH	-W/T	3,000	15,000			178	390*205*31	120,000	6.964

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